

SANYO Semiconductors **DATA SHEET**

LC863364C,LC863356C LC863348C,LC863340C LC863332C,LC863328C LC863324C,LC863320C LC863316C

CMOS IC 64K/56K/48K/40K/32K/28K/24K/20K/16K-byte ROM, CGROM16K-byte on-chip 640/512-byte RAM and 352×9-bit OSD RAM

8-bit 1-chip Microcontroller

Overview

The LC863364C/56C/48C/40C/32C/28C/24C/20C/16C are 8-bit single chip microcontrollers with the following on-chip functional blocks:

- CPU : Operable at a minimum bus cycle time of 0.424µs
- On-chip ROM capacity

Program ROM: 64K/56K/48K/40K/32K/28K/24K/20K/16K bytes

CGROM: 16K bytes

- On-chip RAM capacity: 640/512 bytes
- OSD RAM: 352×9 bits
- Five channels×8-bit AD Converter
- Three channels×7-bit PWM
- Two 16-bit timer/counters, 14-bit base timer
- 8-bit synchronous serial interface circuit
- IIC-bus compliant serial interface circuit (Multi-master type)
- ROM correction function
- 15-source 9-vectored interrupt system
- Integrated system clock generator and display clock generator

X'tal oscillator (32.768kHz) for PLL reference is used for TV control

All of the above functions are fabricated on a single chip.

Note: This product includes the IIC bus interface circuit. If you intend to use the IIC bus interface, please notify us of this in advance of our receiving your program ROM code order.

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Features

■Read-Only Memory (ROM): 65536×8 bits / 57344×8 bits / 49152×8 bits /

40960×8 bits / 32768×8 bits / 28672×8 bits /

24576×8 bits / 20480×8 bits / 16384×8 bits for program

16128×8 bits for CGROM

■Random Access Memory (RAM): 512×8 bits (working area): LC863364C/56C/48C/40C

384×8 bits (working area): LC863332C/28C/24C/20C/16C

128×8 bits (working or ROM correction function)

352×9 bits (for CRT display)

■OSD Functions

Screen display : 36 characters×16 lines (by software)
RAM : 352 words (9 bits per word)

Display area : 36 words×8 lines Control area : 8 words×8 lines

Characters

Up to 252 kinds of 16×32 dot character fonts (4 characters including 1 test character are not programmable) Each font can be divided into two parts and used as two fonts: a 16×17 dot and 8×9 dot character font

• Various character attributes

Character colors : 16colors Character background colors : 16colors Fringe / shadow colors : 16colors Full screen colors : 16colors

Rounding Underline

Italic character (slanting)

- Attribute can be changed without spacing
- Vertical display start line number can be set for each row independently (Rows can be overlapped)
- Horizontal display start position can be set for each row independently
- Horizontal pitch (9 to 16 dots)*1 and vertical pitch (1 to 32 dots) can be set for each row independently
- Different display modes can be set for each row independently

Caption • Text mode / OSD mode 1 / OSD mode 2 (Quarter size) / Simplified graphic mode

• Ten character sizes *1

Horez.
$$\times$$
 Vert. = (1×1), (1×2), (2×2), (2×4), (0.5×0.5)
(1.5×1), (1.5×2), (3×2), (3×4), (0.75×0.5)

- Shuttering and scrolling on each row
- Simplified Graphic Display

Note *1: range depends on display mode: refer to the manual for details.

■Bus Cycle Time / Instruction-Cycle Time

Bus Cycle Time	Instruction Cycle Time	System Clock Oscillation	Oscillation Frequency	Voltage
0.424μs	0.848μs	Internal VCO	14.156MHz	4.5V to 5.5V
		(Ref : X'tal 32.768kHz)		
7.5µs	15.0μs	Internal RC	800kHz	4.5V to 5.5V
183.1μs	366.2μs	Crystal	32.768kHz	4.5V to 5.5V

■Ports

• Input / Output Ports : 5 ports (28 terminals)
Data direction programmable in nibble units : 1 port (8 terminals)

(If the N-ch open drain output is selected by option, the corresponding port data can be read in output mode.)

Data direction programmable for each bit individually : 4 ports (20 terminals)

• Input port : 1 port (1 terminal)

■AD Converter

• 5 channels×8-bit AD converters

■Serial Interfaces

• IIC-bus compliant serial interface (Multi-master type)

Consists of a single built-in circuit with two I/O channels. The two data lines and two clock lines can be connected internally.

• Synchronous 8-bit serial interface

■PWM Output

• 3 channels×7-bit PWM

■Timer

• Timer 0 : 16-bit timer/counter

With 2-bit prescaler + 8-bit programmable prescaler

Mode 0: Two 8-bit timers with a programmable prescaler

Mode 1:8-bit timer with a programmable prescaler + 8-bit counter

Mode 2: 16-bit timer with a programmable prescaler

Mode 3: 16-bit counter

The resolution of timer is 1 tCYC.

• Timer 1: 16-bit timer/PWM

Mode 0: Two 8-bit timers

Mode 1:8-bit timer + 8-bit PWM

Mode 2: 16-bit timer

Mode 3: Variable bit PWM (9 to 16 bits)

In mode0/1, the resolution of Timer1/PWM is 1 tCYC

In mode2/3, the resolution is selectable by program; tCYC or 1/2 tCYC

• Base timer

Generate every 500ms overflow for a clock application

(using 32.768kHz crystal oscillation for the base timer clock)

Generate every 976µs, 3.9ms, 15.6ms, 62.5ms overflow

(using 32.768kHz crystal oscillation for the base timer clock)

Clock for the base timer is selectable from $32.768 \mathrm{kHz}$ crystal oscillation, system clock or programmable prescaler output of Timer 0

- ■Remote Control Receiver Circuit (connected to the P73/INT3/T0IN terminal)
 - Noise rejection function
 - Polarity switching

■Watchdog Timer

External RC circuit is required

Interrupt or system reset is activated when the timer overflows

■ROM Correction Function

Max 128 bytes / 2 addresses

■Interrupts

- 15 sources 9 vectored interrupts
 - 1. External Interrupt INTO
 - 2. External Interrupt INT1
 - 3. External Interrupt INT2, Timer/counter T0L (Lower 8 bits)
 - 4. External Interrupt INT3, base timer
 - 5. Timer/counter T0H (Upper 8 bits)
 - 6. Timer T1H,T1L
 - 7. SIO0
 - 8. Vertical synchronous signal interrupt (\overline{VS}), horizontal line (\overline{HS}), AD
 - 9. IIC, Port 0
- Interrupt priority control

Three interrupt priorities are supported (low, high and highest) and multi-level nesting is possible. Low or high priority can be assigned to the interrupts from 3 to 9 listed above. For the external interrupt INTO and INT1, low or highest priority can be set.

■Sub-routine Stack Level

• A maximum of 128 levels (stack is built in the internal RAM)

■Multiplication/division Instruction

- 16 bits×8 bits (7 instruction cycle times)
- 16 bits÷8 bits (7 instruction cycle times)

■3 Oscillation Circuits

- Built-in RC oscillation circuit used for the system clock
- Built-in VCO circuit used for the system clock and OSD
- X'tal oscillation circuit used for base timer, system clock and PLL reference

■Standby Function

• HALT mode

The HALT mode is used to reduce the power dissipation. In this operation mode, the program execution is stopped. This mode can be released by the interrupt request or the system reset.

• HOLD mode

The HOLD mode is used to stop the oscillations; RC (internal), VCO, and X'tal oscillations. This mode can be released by the following conditions.

- Pull the reset terminal (\overline{RES}) to low level.
- Feed the selected level to either P70/INT0 or P71/INT1.
- Input the interrupt condition to Port 0.

■Package

- DIP42S (Lead-free type)
- QIP48E (Lead-free type)

■Development Tools

Flash EEPROM: LC86F3364AEvaluation chip: LC863096

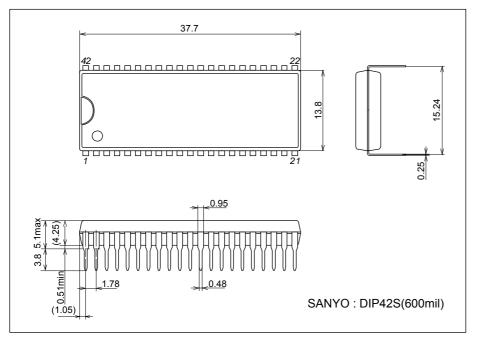
• Emulator: EVA86000 (main) + ECB863200* or ECB863200A (evaluation chip board)

+ POD863300 (pod: DIP42S) or POD863301 (pod: QIP48E)

* This product is no longer available

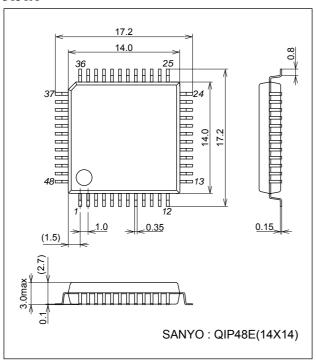
Package Dimensions

unit : mm 3025C

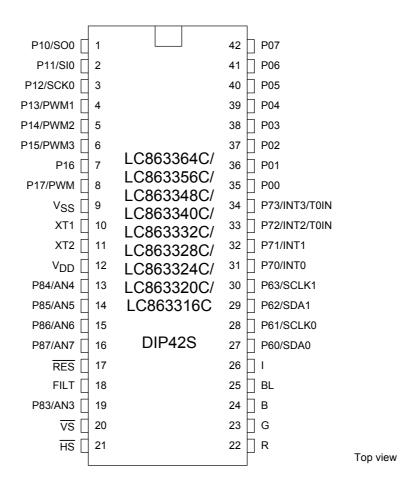


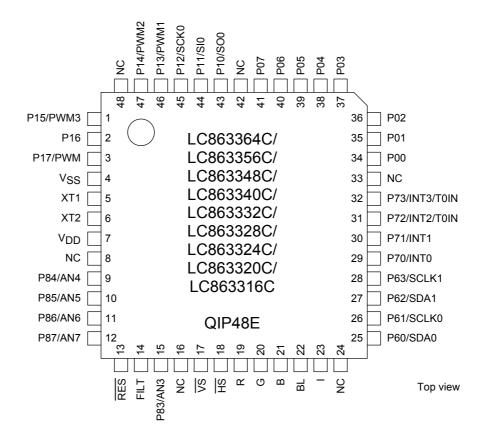
Package Dimensions

unit : mm 3156A

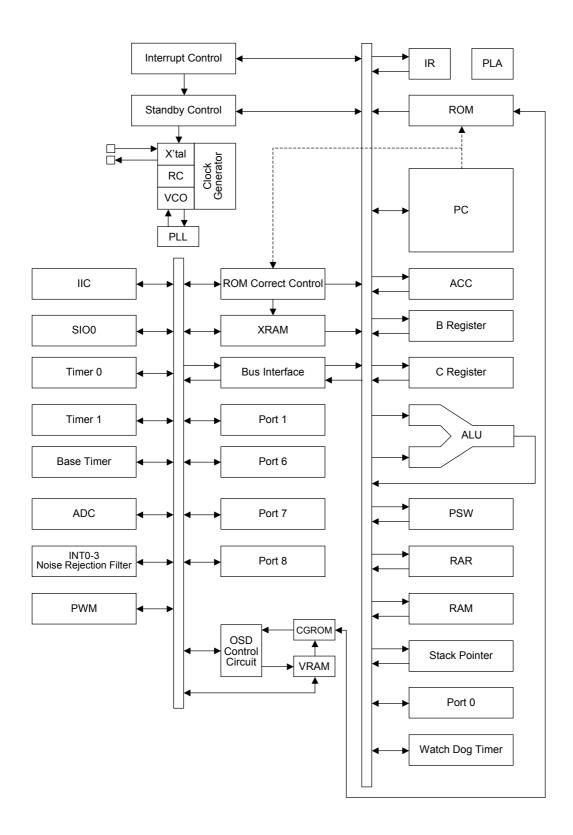


Pin Assignments





System Block Diagram



Pin Description

Pin Description Table

Terminal	1/0	Function Description	Option
V _{SS}	-	Negative power supply	
XT1	ı	Input terminal for crystal oscillator	
XT2	0	Output terminal for crystal oscillator	
V _{DD}	-	Positive power supply	
RES	I	Reset terminal	
FILT	0	Filter terminal for PLL	
VS	ı	Vertical synchronization signal input terminal	
HS	I	Horizontal synchronization signal input terminal	
R	0	Red (R) output terminal of RGB image output	
G	0	Green (G) output terminal of RGB image output	
В	0	Blue (B) output terminal of RGB image output	
1	0	Intensity (I) output terminal of RGB image output	
BL	0	Fast blanking control signal Switch TV image signal and OSD image signal	
Port 0	I/O	•8-bit input/output port,	Pull-up resistor
P00 to P07		Input/output can be specified in nibble unit Other functions HOLD release input Interrupt input	provided/not provided Output Format CMOS/Nch-OD
Port 1	I/O	•8-bit input/output port	Output Format
P10 to P17	- ""	Input/output can be specified in a bit Other functions	CMOS/Nch-OD
		P10 SIO0 data output P11 SIO0 data input/bus input/output P12 SIO0 clock input/output P13 PWM1 output P14 PWM2 output P15 PWM3 output P17 Timer1 (PWM) output	
Port 6	I/O	•4-bit input/output port	
P60 to P63		Input/output can be specified for each bit •Other functions P60 IIC0 data I/O P61 IIC0 clock output P62 IIC1 data I/O P63 IIC1 clock output	

Continued on next page.

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Terminal	I/O			Fun	ction Descr	iption			Option
Port 7	I/O	•4-bit input/o	utput port						
P70		Input or out	out can be	specified fo	r each bit				
P71 to P73		Other functi	ons						_
		P70	INT0 in						
			Nch-Tr. output for watchdog timer						
		P71	INT1 in	put/HOLD r	release inpu	ıt			
		P72	INT2 in	put/Timer 0	event inpu	t			
		P73	INT3 in	put (noise r	ejection filte	er connecte	ed)/		
			Timer 0	event inpu	ıt]
		Interrupt rec	eiver forma	t, vector ad	dresses				
			Rising	Falling	Rising/ Falling	H level	L level	Vector	
		INT0	enable	enable	disable	enable	enable	03H]
		INT1	enable	enable	disable	enable	enable	0BH	
		INT2	enable	enable	enable	disable	disable	13H]
		INT3	enable	enable	enable	disable	disable	1BH]
Port 8	I	•1-bit input p	ort						
P83		4-bit input/o	utput port						
P84 to P87	I/O	Input or out		specified fo	r each bit				
		Other functi	on						
		AD converte	er input por	t (5 lines)					
NC	-	Unused term	inal						
		Leave open							

- Output form and existence of pull-up resistor for all ports can be specified for each bit.
- Programmable pull-up resistor is always connected regardless of port option, CMOS or N-ch open drain output in port 1.

Port status in reset

Terminal	I/O	Pull-up resistor status at selecting pull-up option
Port 0	1	Pull-up resistor OFF, ON after reset release
Port 1	I	Programmable pull-up resistor OFF

Absolute Maximum Ratings at $Ta = 25^{\circ}C$, $V_{SS} = 0V$

Dave		Comment of	Dies	Conditions			Ratings	3	
Para	ameter	Symbol	Pins	Conditions	V _{DD} [V]	min	typ	max	unit
Maximum voltage	supply	V _{DD} max	V_{DD}			-0.3		+6.5	
Input volta	age	V _I (1)	RES, HS, VS, P83			-0.3		V _{DD} +0.3	v
Output vol	Itage	V _O (1)	R, G, B, I, BL, FILT			-0.3		V _{DD} +0.3	V
Input/output voltage		V _{IO}	Ports 0, 1, 6, 7, 84 to 87			-0.3		V _{DD} +0.3	
High level	Peak output	IOPH(1)	Ports 0, 1, 7, 84 to 87	•CMOS output •For each pin.		-4			
output current	current	IOPH(2)	R, G, B, I, BL	•CMOS output •For each pin.		-5			
	Total	ΣIOAH(1)	Ports 0, 1	Total of all pins.		-20			
	output	ΣΙΟΑΗ(2)	Ports 7, 84 to 87	Total of all pins.		-10			
	current	ΣΙΟΑΗ(3)	R, G, B, I, BL	Total of all pins.		-15			mA
Low	Peak	IOPL(1)	Ports 0, 1, 6, 84 to 87	For each pin.				20	
level	output	IOPL(2)	Port 7	For each pin.				15	
output current	current	IOPL(3)	R, G, B, I, BL	For each pin.				5	
Cullent	Total	ΣIOAL(1)	Ports 0, 1	Total of all pins.				40	
	output	ΣIOAL(2)	Ports 6, 7, 84 to 87	Total of all pins.				40	
	current	ΣIOAL(3)	R, G, B, I, BL	Total of all pins.				15	
Maximum	power	Pd max	DIP42S	Ta=-10 to +70°C				715	mW
dissipation	n		QIP48E					385	mvv
Operating temperaturange		Topr				-10		+70	
Storage temperatu	ıre	Tstg				-55		+125	°C

Recommended Operating Range at $Ta = -10^{\circ}C$ to $+70^{\circ}C$, $V_{SS} = 0V$

Parameter	Symbol	Pins	Conditions			Ratings	3	mit
Parameter	Symbol	PILIS	Conditions	V _{DD} [V]	min	typ	max	unit
Operating	V _{DD} (1)	V_{DD}	0.844μs ≤ tCYC ≤ 0.852μs		4.5		5.5	
supply voltage range	V _{DD} (2)		4μs ≤ tCYC ≤ 400μs		4.5		5.5	
Hold voltage	VHD	V _{DD}	RAMs and the registers data are kept in HOLD mode.		2.0		5.5	
High level input	V _{IH} (1)	Port 0 (Schumitt)	Output disable	4.5 to 5.5	0.6V _{DD}		V_{DD}	
voltage	V _{IH} (2)	Ports 1,6 (Schumitt) Port 7 (Schumitt) port input/interrupt HS, VS, RES (Schumitt)	Output disable	4.5 to 5.5	0.75V _{DD}		V _{DD}	
	V _{IH} (3)	Port 70 Watchdog timer input	Output disable	4.5 to 5.5	V _{DD} -0.5		V_{DD}	٧
	V _{IH} (4)	•Port 8 port input	Output disable	4.5 to 5.5	0.7V _{DD}		V _{DD}	
Low level input	V _{IL} (1)	Port 0 (Schumitt)	Output disable	4.5 to 5.5	V _{SS}		0.2V _{DD}	
voltage	V _{IL} (2)	Ports 1,6 (Schumitt) Port 7 (Schumitt) port input/interrupt HS, VS, RES (Schumitt)	Output disable	4.5 to 5.5	V _{SS}		0.25V _{DD}	
	V _{IL} (3)	Port 70 Watchdog timer input	Output disable	4.5 to 5.5	V _{SS}		0.6V _{DD}	
	V _{IL} (4)	Port 8 port input	Output disable	4.5 to 5.5	V _{SS}		0.3V _{DD}	
Operation cycle time	tCYC(1)		•All functions operating	4.5 to 5.5	0.844	0.848	0.852	
	tCYC(2)		•AD converter operating •OSD is not operating	4.5 to 5.5	0.844		30	μs
	tCYC(3)		OSD and AD converter are not operating	4.5 to 5.5	0.844		400	
Oscillation frequency range	FmRC		Internal RC oscillation	4.5 to 5.5	0.4	0.8	3.0	MHz

Electrical Characteristics at $Ta = -10^{\circ}C$ to $+70^{\circ}C$, $V_{SS} = 0V$

D	0	D'	7 55			Ratings		
Parameter	Symbol	Pins	Conditions	V _{DD} [V]	min	typ	max	unit
High level input current	l _{IH} (1)	Ports 0, 1, 6, 7, 8	Output disable Pull-up MOS Tr. OFF VIN=VDD (including the off-leak current of the output Tr.)	4.5 to 5.5			1	
	I _{IH} (2)	• RES • HS , VS	•V _{IN} =V _{DD}	4.5 to 5.5			1	4
Low level input current	l _{IL} (1)	Ports 0, 1, 6, 7, 8	Output disable Pull-up MOS Tr. OFF VIN=VSS (including the off-leak current of the output Tr.)	4.5 to 5.5	-1			μΑ
	I _{IL} (2)	• RES • HS , VS	V _{IN} =V _{SS}	4.5 to 5.5	-1			
High level output voltage	V _{OH} (1)	•CMOS output of ports 0, 1, 71 to 73, 84 to 87	I _{OH} =-1.0mA	4.5 to 5.5	V _{DD} -1			
	V _{OH} (2)	R, G, B, I, BL	I _{OH} =-0.1mA	4.5 to 5.5	V _{DD} -0.5			
Low level output voltage	V _{OL} (1)	Ports 0, 1, 71 to 73, 84 to 87	I _{OL} =10mA	4.5 to 5.5			1.5	
	V _{OL} (2)	Ports 0, 1, 71 to 73, 84 to 87	I _{OL} =1.6mA	4.5 to 5.5			0.4	V
	V _{OL} (3)	•R, G, B, I, BL •Port 6	I _{OL} =3.0mA	4.5 to 5.5			0.4	
	V _{OL} (4)	Port 6	I _{OL} =6.0mA	4.5 to 5.5			0.6	
	V _{OL} (5)	Port 70	I _{OL} =1mA	4.5 to 5.5			0.4	
Pull-up MOS Tr. resistance	Rpu	Ports 0, 1, 7, 84 to 87	V _{OH} =0.9V _{DD}	4.5 to 5.5	13	38	80	kΩ
Bus terminal short circuit resistance (SCL0 to SCL1, SDA0 to SDA1)	RBS	•P60 to P62 •P61 to P63		4.5 to 5.5		130	300	Ω
Hysteresis voltage	VHYS	•Ports 0, 1, 6, 7 • RES • HS , √S	Output disable	4.5 to 5.5		0.1V _{DD}		٧
Pin capacitance	СР	All pins	•f=1MHz •Every other terminals are connected to V _{SS} . •Ta=25°C	4.5 to 5.5		10		pF

Serial Input/Output Characteristics at $Ta = -10^{\circ}C$ to $+70^{\circ}C$, $V_{SS} = 0V$

		Parameter	Cumbal	Pins	Conditions			Ratings	S	unit
		Parameter	Symbol	PINS	Conditions	V _{DD} [V]	min	typ	max	unit
	×	Cycle	tCKCY(1)	•SCK0 •SCLK0	Refer to figure 4.		2			
	Input clock	Low Level pulse width	tCKL(1)			4.5 to 5.5	1			
Serial clock	ul	High Level pulse width	tCKH(1)				1			1000
Serial	S	Cycle	tCKCY(2)	•SCK0 •SCLK0	•Use pull-up resistor (1kΩ)		2			tCYC
	Output clock	Low Level pulse width	tCKL(2)		when Nch open- drain output.	4.5 to 5.5		1/2tCKCY		
	ō	High Level pulse width	tCKH(2)		•Refer to figure 4.			1/2tCKCY		
Serial input	Da	ta set up time	tICK	SIO	•Data set-up to SCK0. •Data hold from	451.55	0.1			
Serial	Da	ta hold time	tCKI		SCK0. •Refer to figure 4.	4.5 to 5.5	0.1			
Serial output		tput delay time sing external clock)	tCKO(1)	S00	Data hold from SCK0. Use pull-up resistor (1kΩ)	4.5 to 5.5			7/12tCYC +0.2	μs
Serial		utput delay time sing internal clock)	tCKO(2)	S00	when Nch open- drain output. •Refer to figure 4.	4.5 to 5.5			1/3tCYC +0.2	

IIC Input/Output Conditions at $Ta = -10^{\circ}C$ to $+70^{\circ}C$, $V_{SS} = 0V$

Description	O. made at	Stan	dard	High spe		
Parameter	Symbol	min	max	min	max	unit
SCL Frequency	fSCL	0	100	0	400	kHz
BUS free time between stop - start	tBUF	4.7	-	1.3	-	μs
HOLD time of start, restart condition	tHD;STA	4.0	-	0.6	-	μs
L time of SCL	tLOW	4.7	-	1.3	-	μs
H time of SCL	tHIGH	4.0	-	0.6	-	μs
Set-up time of restart condition	tSU;STA	4.7	-	0.6	-	μs
HOLD time of SDA	tHD;DAT	0	-	0	0.9	μs
Set-up time of SDA	tSU;DAT	250	-	100	-	ns
Rising time of SDA, SCL	tR	-	1000	20+0.1Cb	300	ns
Falling time of SDA, SCL	tF	-	300	20+0.1Cb	300	ns
Set-up time of stop condition	tSU;STO	4.0	-	0.6	-	μs

Refer to figure 9

Note 1: Cb: Total capacitance of all BUS (unit : pF)

Pulse Input Conditions at $Ta = -10^{\circ}C$ to $+70^{\circ}C$, $V_{SS} = 0V$

Parameter	Symbol	Pins	Conditions			Ratings		unit
Parameter	Symbol	PIIIS	Conditions	V _{DD} [V]	min	typ	max	unit
High/low level	tPIH(1)	•INT0, INT1	•Interrupt acceptable	4.5 to 5.5	1			
pulse width	tPIL(1)	•INT2/T0IN	•Timer0-countable	4.5 to 5.5	'			
	tPIH(2)	INT3/T0IN	•Interrupt acceptable					
	tPIL(2)	(1tCYC is selected for noise	•Timer0-countable	4.5 to 5.5	2			
		rejection clock.)						
	tPIH(3)	INT3/T0IN	•Interrupt acceptable					tCYC
	tPIL(3)	(16tCYC is selected for	•Timer0-countable	4.5 to 5.5	32			
		noise rejection clock.)						
	tPIH(4)	INT3/T0IN	•Interrupt acceptable					
	tPIL(4)	(64tCYC is selected for	•Timer0-countable	4.5 to 5.5	128			
		noise rejection clock.)						
	tPIL(5)	RES	Reset acceptable	4.5 to 5.5	200			
	tPIH(6)	HS, VS	•Display position controllable					
	tPIL(6)		•The active edge of					μs
			HS and VS must be apart	4.5 to 5.5	8			μδ
			at least 1tCYC.					
			•Refer to figure 6.					
Rising/falling	tTHL	HS	Refer to figure 6.	4.5 to 5.5			500	
time	tTLH			4.5 (0 5.5			500	ns

AD Converter Characteristics at $Ta = -10^{\circ}C$ to $+70^{\circ}C$, $V_{SS} = 0V$

Danamatan	O. mak al	Dina	Conditions				unit	
Parameter	Symbol	Pins	Conditions	V _{DD} [V]	min	typ	max	unit
Resolution	N					8		bit
Absolute precision	ET		(Note 3)				±1.5	LSB
Conversion time	tCAD		ADCR2=0 (Note 4)			16		10)/0
			ADCR2=1 (Note 4)	4.5 to 5.5		32		tCYC
Analog input voltage range	VAIN	AN3 to AN7			V _{SS}		V _{DD}	٧
Analog port	IAINH		VAIN=V _{DD}				1	
input current	IAINL		VAIN=V _{SS}		-1			μА

Note 3: Absolute precision does not include quantizing error (1/2LSB).

Note 4: Conversion time is the time till the complete digital conversion value for analog input value is set to a register after the instruction to start conversion is sent.

Sample Current Dissipation Characteristics at $Ta = -10^{\circ}C$ to $+70^{\circ}C$, $V_{SS} = 0V$

The sample current dissipation characteristics is the measurement result of Sanyo provided evaluation board when the recommended circuit parameters shown in the sample oscillation circuit characteristics are used externally.

The currents through the output transistors and the pull-up MOS transistors are ignored.

Bernette	0	D'	0 - 175			Ratings		- 11
Parameter	Symbol	Pins	Conditions	V _{DD} [V]	min	typ	max	unit
Current dissipation during basic operation (Note 5)	IDDOP(1)	V _{DD}	•FmX'tal=32.768kHz X'tal oscillation •System clock: VCO •VCO for OSD operating •Internal RC oscillation stops	4.5 to 5.5		8	21	mA
Current dissipation in HALT mode (Note 5)	IDDHALT(1)	V _{DD}	•HALT mode •FmX'tal=32.768kHz X'tal oscillation •System clock : VCO •VCO for OSD stops •Internal RC oscillation stops	4.5 to 5.5		3	9	mA
	IDDHALT(2)	V _{DD}	*HALT mode *FmX'tal=32.768kHz X'tal oscillation *VCO for system stops *VCO for OSD stops *System clock : Internal RC	4.5 to 5.5		300	1000	
	IDDHALT(3)	V _{DD}	HALT mode FmX'tal=32.768kHz X'tal oscillation VCO for system stops VCO for OSD stops System clock: X'tal	4.5 to 5.5		45	200	μΑ
Current dissipation in HOLD mode (Note 5)	IDDHOLD	V _{DD}	•HOLD mode •All oscillation stops.	4.5 to 5.5		0.05	20	μА

Note 5: The currents through the output transistors and the pull-up MOS transistors are ignored.

Recommended Oscillation Circuit and Sample Characteristics

The sample oscillation circuit characteristics in the table below is based on the following conditions:

Recommended circuit parameters are verified by an oscillator manufacturer using a Sanyo provided oscillation evaluation board.

Sample characteristics are the result of the evaluation with the recommended circuit parameters connected externally.

Recommended oscillation circuit and sample characteristics ($Ta = -10^{\circ}C$ to $+70^{\circ}C$)

Frequency	Manufacturer	Oscillator	Recommended circuit parameters				Operating supply	Oscillation stabilizing time		Notes
			C1	C2	Rf	Rd	voltage range	typ	max	
32.768kHz	SEIKO EPSON	C-002RX	18pF	18pF	OPEN	390kΩ	4.5 to 5.5V	1.0s	1.5s	

Notes: The oscillation stabilizing time period is the time until the VCO oscillation for the internal system becomes stable after the following conditions. (Refer to Figure 2.)

- 1. The V_{DD} becomes higher than the minimum operating voltage after the power is supplied.
- 2. The HOLD mode is released.

The sample oscillation circuit characteristics may differ applications. For further assistance, please contact with oscillator manufacturer with the following notes in your mind.

- Since the oscillation frequency precision is affected by wiring capacity of the application board, etc., adjust the oscillation frequency on the production board.
- The above oscillation frequency and the operating supply voltage range are based on the operating temperature of -10°C to +70°C. For the use with the temperature outside of the range herein, or in the applications requiring high reliability such as car products, please consult with oscillator manufacturer.
- When using the oscillator which is not shown in the sample oscillation circuit characteristics, please consult with Sanyo sales personnel.

Since the oscillation circuit characteristics are affected by the noise or wiring capacity because the circuit is designed with low gain in order to reduce the power dissipation, refer to the following notices.

- The distance between the clock I/O terminal (XT1 terminal XT2 terminal) and external parts should be as short as possible.
- The capacitors' VSS should be allocated close to the microcontroller's GND terminal and be away from other GND.
- The signal lines with rapid state changes or with large current should be allocated away from the oscillation circuit.

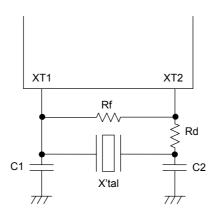
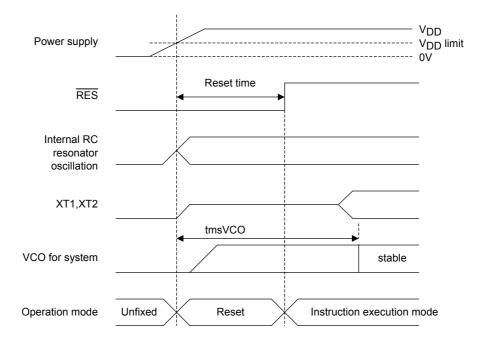
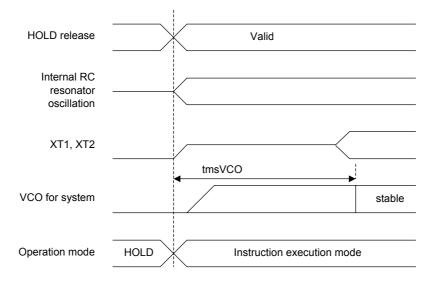


Figure 1 Recommended Oscillation Circuit

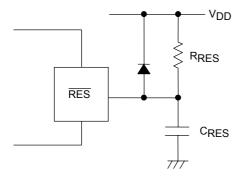


Reset Time and Oscillation Stabilizing Time



HOLD Release Signal and Oscillation Stabilizing Time

Figure 2 Oscillation Stabilizing Time



Note: Determine the CRES, RRES value to generate more than $200\mu s$ reset time.

Figure 3 Reset Circuit



AC Timing Measurement Point

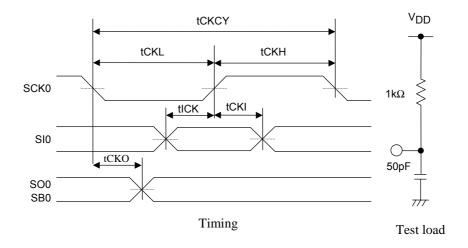


Figure 4 Serial Input / Output Test Condition

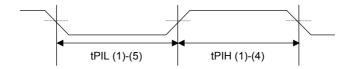


Figure 5 Pulse Input Timing Condition - 1

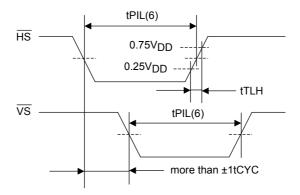


Figure 6 Pulse Input Timing Condition - 2

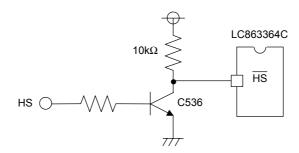


Figure 7 Recommended Interface Circuit

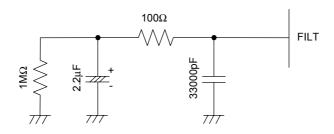
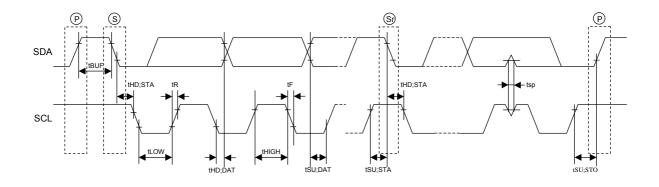


Figure 8 FILT Recommended Circuit

Note: Place FILT parts on board as close to the microcontroller as possible.



S : start condition
P : stop condition
Sr : restart condition

tsp: spike suppression

Standard mode : not exist High speed mode : less than 50ns

Figure 9 IIC Timing

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